

Ps	N.S. $x=0$	Z $x=1$
A	A-0	B-0
B	C-0	D-0
C	A-0	D-0
D	E-0	F-1
E	A-0	F-1
F same	G-0	F-1
G	A-0	F-1

Equal

here $E = G$.

P-S	N.S. $x=0$	Z $x=1$
A	A-0	B-0
B	C-0	D-0
C	A-0	D-0
D	E-0	F-1
E same	A-0	F-1
F	E-0	F-1

Equal

here $D = F$

P-S	N.S. $x=0$	Z $x=1$
A	A-0	B-0
B	C-0	D-0
C	A-0	D-0
D	E-0	F-1
E	A-0	F-1

RAM

Random Access memory

→ RAM is a volatile memory which could store the data as long as the power is supplied

→ Data stored in RAM can be retrieved and altered

→ It is a high speed memory

→ The CPU can access the data stored on it

→ large size with higher capacity

→ The data stored is easily accessible

→ costlier

→ Data in RAM can be modified

→ RAM sizes from 64 MB to 4 GB

→ Type of RAM are Static RAM and dynamic RAM

ROM

Read Only memory

→ ROM is a non-volatile memory which could retain the data even when power is turned off

→ Data stored in ROM can only be read

→ It is much slower than the RAM

→ The CPU can not access the data stored on it unless the data is stored in RAM.

→ Small size with less capacity

→ The data stored is not as easily accessible as in RAM

cheaper than RAM

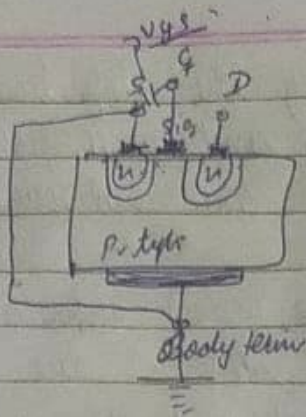
Data in ROM can not be modified

→ ROM is comparatively smaller than RAM

→ Type of ROM are PROM, EPROM, EEPROM

MOSFET

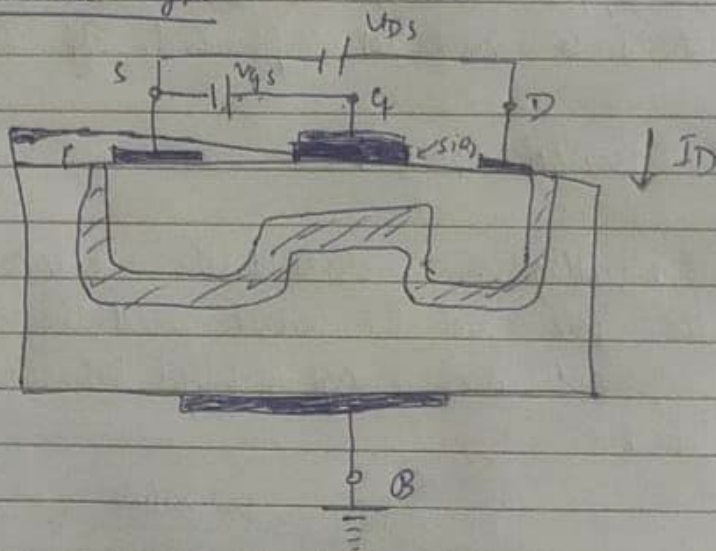
or



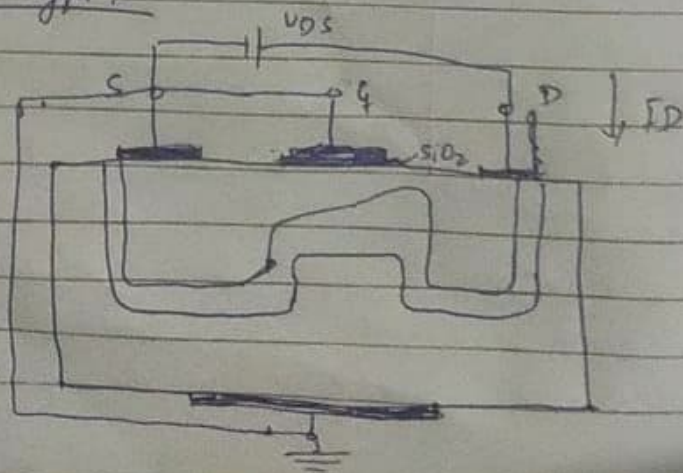
SiO₂ → insulator

$V_{gs} = 0$
Depletion type

Enhancement type



Depletion type :-

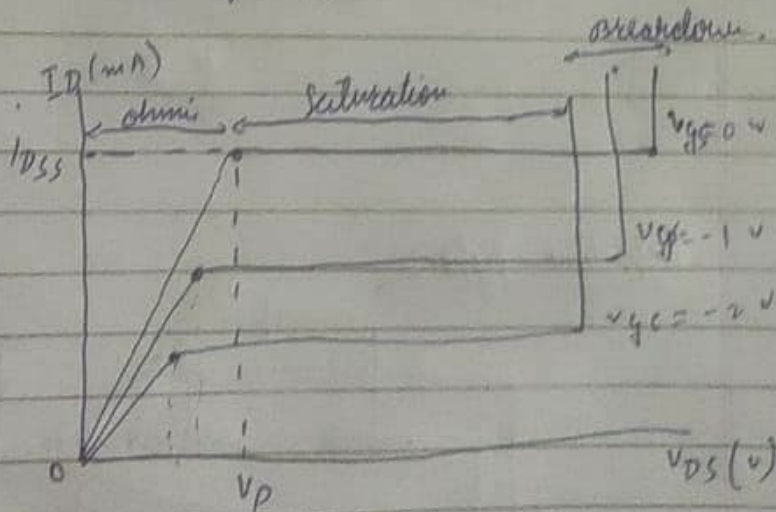


large portion of the depletion region formed between the gate drain and small portion of the depletion region between gate and source.

If small voltage (V_{DS}) applied between the drain-source with zero gate (V_G) the current (I_D) will flow through this channel now if we apply a small amount of negative voltage ($-V_G$) (i.e. reverse biased condition) then the depletion region width increases, which results in decreasing the portion of the channel length and reduce the conduction of the channel. The applied voltage at which the channel of FET closes is called as "pinched off voltage (V_P)".

V-I Characteristics

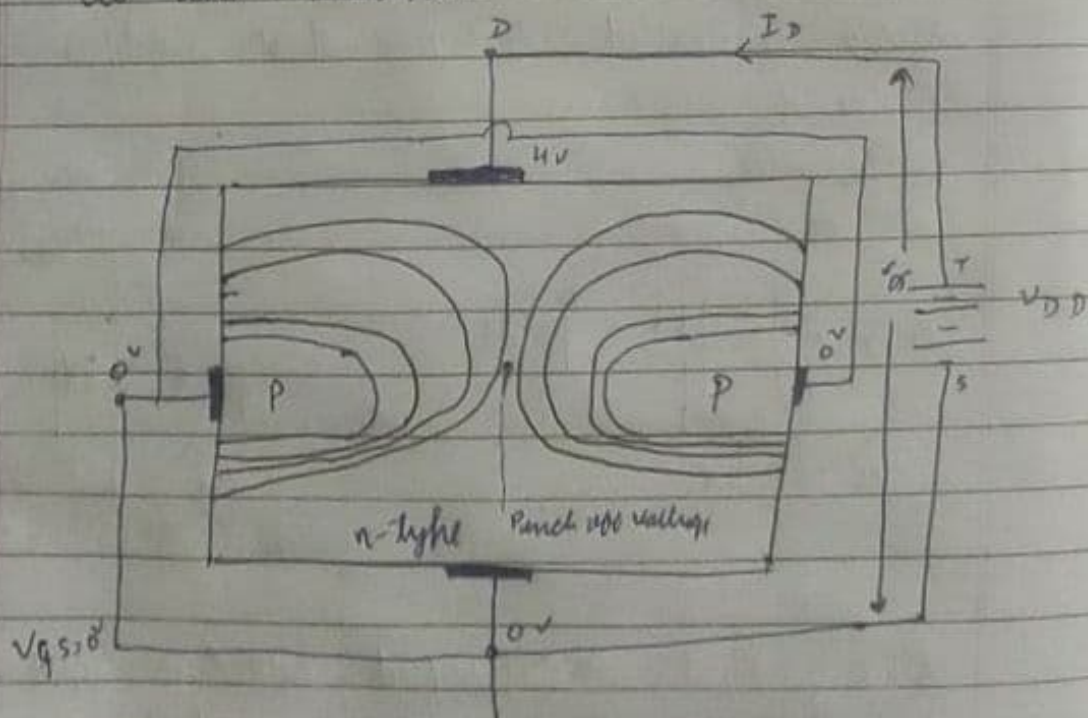
The voltage V_G represent the voltage applied between the gate and the source and the voltage V_{DS} represents the voltage applied between the drain and source.



N-channel JFET are widely used than P-channel JFET's. The small voltage at the gate (V_g) terminal control the current flow in the channel (between gate drain and source) of the JFET.

N-channel JFET biasing:-

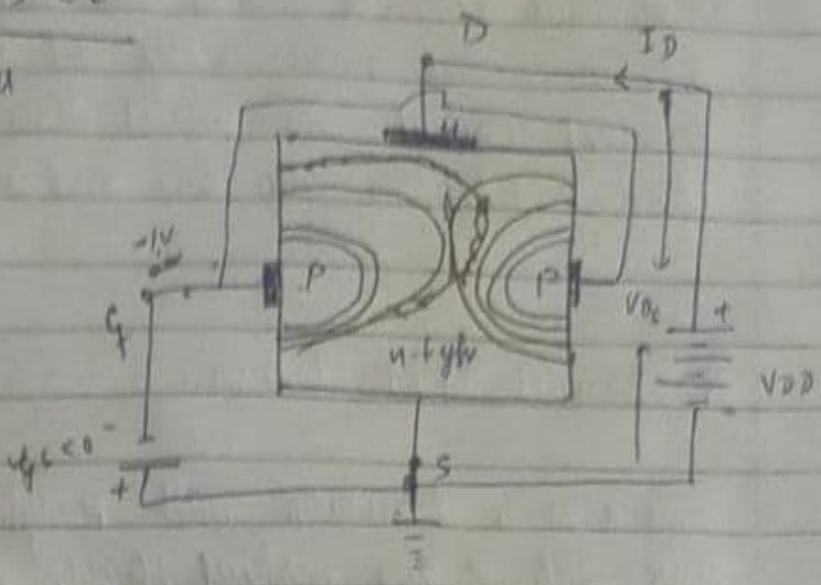
This is a transistor with n-type of channel and with p-type material (highly doped) of the region. If the gate is diffused into the n-type channel, then a reverse bias PN junction is formed which result a depletion region around the gate terminal when no external supply is applied to the transistor.



The depletion region produces a μ

Now the channel of JFET conducts with zero bias voltage applied as input. Because of the

for $v_{gs} < 0$
n-channel

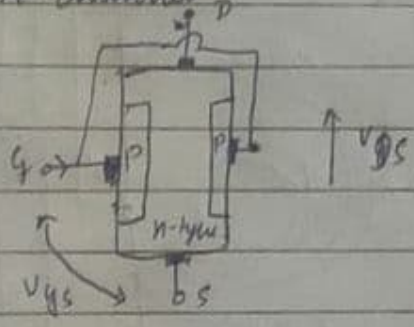


JFET:-

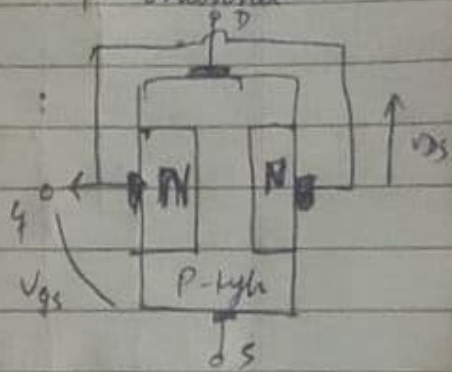
The Junction field effect transistor (JFET) is one of the types of FET transistors. JFET is a three terminal device, it is used as electronically controlled switches, voltage controlled resistor and as amplifier.

Types of JFET

n-channel



p-channel



The JFET are classified into two types, they are N-channel JFET and P-channel JFET.

The N-channel JFET has more current conduction than P-channel JFET because the mobility of electron is greater than the mobility of holes. So the

		$C+D$ 00	CD' 01	$C'D$ 11	$C'D'$ 10
AB 00		0		1	0
AB' 01			4	5	6
$A'B'$ 11		12	13	14	
$A'B$ 10		8	9	11	10

$$1 \rightarrow A' + C$$

$$2 \rightarrow A' + B' + D'$$

$$3 \rightarrow A + B + C'$$

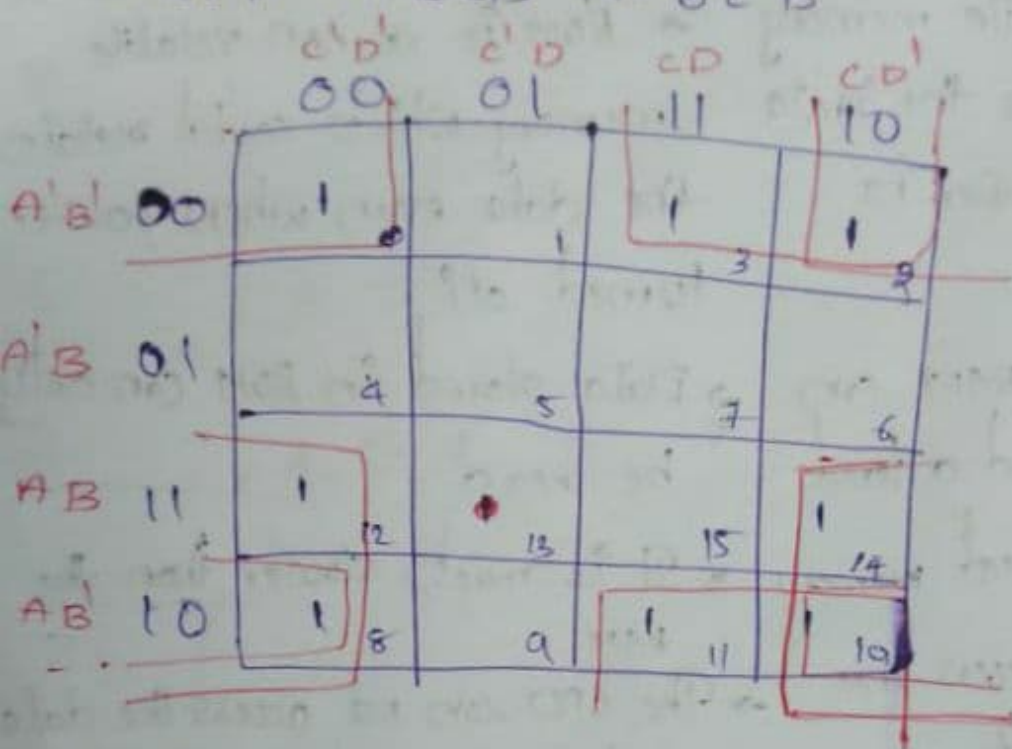
$$4 \rightarrow A + B + D$$

$$F = (A' + C) + (A' + B' + D') + (A + B + C') + (A + B + D)$$

> b >

$$y = \bar{A}'B'CD' + ABCD' + AB'CD' + AB'CD + ABC'D' +$$

$$ABC'D + A'B'CD + A'B'C'D'$$



$$= (8, 14, 10, 11, 8, 12, 3, 0,)$$

$$= (0, 2, 3, 8, 10, 11, 12, 14)$$

$$1 \rightarrow AD' \quad y \rightarrow AD' + BC + B'D'$$

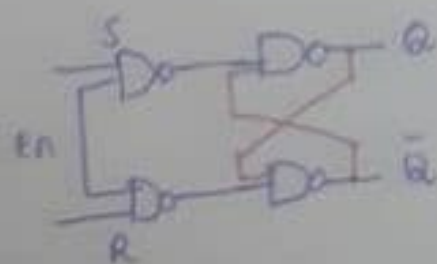
$$2 \rightarrow AB'C$$

$$3 \rightarrow B'D'$$

$$f(A, B, C, D) = \pi M(0, 2, 3, 8, 9, 12, 13, 15)$$

and returns previous state when $en=0$

En	S	R	a_n	a_{n+1}	State
1	0	0	0	0	No change
1	0	1	0	0	Reset
1	1	0	0	1	Set
1	1	1	0	X	Indeterminate
0	X	X	0	0	No change



Q) What is counter? Give the diff
b/w synchronous & asynchronous counter

✓) A counter is a register capable of
counting the no. of clock pulses occurring
at clock input.

Asynchronous

* In this type of counter
flip flops are connected
in such a way that the
output of 1st flip-flop
provides the clock for
the next flip flop.

* All the FF's are
not clocked simultane-
ously.

Synchronous

* In this type of counter,
there is no connection
b/w output of 1st FF
& input of next
flip flop.

* All the FF's are
clocked simultaneously.

Logic around it
very simple even
for more no. of states.

Logic around it
very complex
as no. of states
increases.

Drawback -

Low speed

as the clock is pro-
pagated through
no. of flip flops
before it reaches
last flip flop.

High Speed

As clock is
simultaneously
given to all flip
flops there is no
problem of
propagation delay.

Hence, they are
high speed counters
as are preferred
when no. of
flip flops are more.

State and output Q will be 1

i) When $J=1, K=0, Q=1, S=0, R=0$, Since $SR=00$, there is no change in the output Q i.e.

The inputs $J=1, K=0$, makes $Q=1$, i.e. Set State.

Case 3: $J=0, K=1$

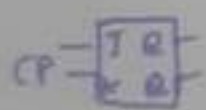
i) When $J=0, K=1, Q=0, S=0, R=0$, Since $SR=00$, there is no change in the output Q i.e. $Q=0, \bar{Q}=1$.

ii) $Q=1, \bar{Q}=0$: When $J=0, K=1, Q=1, S=0, R=1$. According to truth table of SR flip flop it is a reset state i.e. output will be 0.

The inputs $J=0, K=1$ makes $Q=0$
Reset State

Case 4 : $J=K=1$

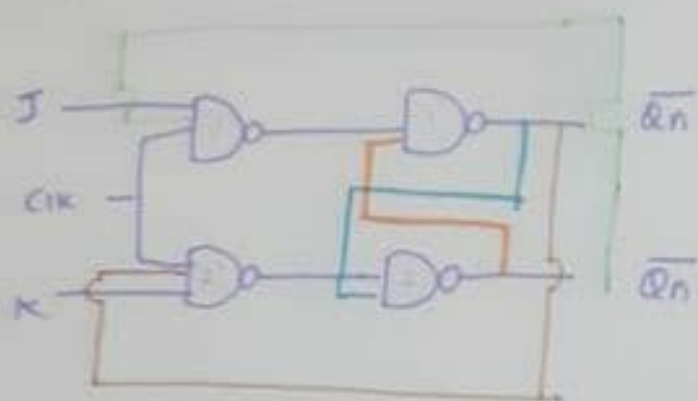
- i) When $J=K=1$ & $Q=0, S=1, R=0$ According to the truth table of SR flip-flop it is a set state & output Q will be 1
- ii) When $J=K=1, Q=1, S=0, R=1$. According to the truth table of SR flip-flop, it is a reset state & output Q will be 0
- The input $J=K=1$, toggles the flip flop output.



Q_n	J	K	Q_{n+1}
0	0	0	0
0	0	1	0
0	1	0	1
0	1	1	1
1	0	0	0
1	0	1	0
1	1	0	1
1	1	1	1

J	K	Q_{n+1}
0	0	Q_n
0	1	0
1	0	\bar{Q}_n
1	1	Q_n

Explain about the operation of JK flip flop



* There is no toggling - only racing
Operation of JK flip-flop

Case 1: $J=K=0$

When $J=K=0$, $S=R=0$ and according to truth table of SR flip flop, there is no change in the output

When inputs $J=K=0$, outputs does not change

Case 2: $J=1, K=0$

When $J=1, K=0, Q=0, S=1, R=1$

According to TT of SR flip flop it is set

13 Difference between BJT and FET

- | Bipolar Junction Transistor | Field Effect Transistor |
|--|---|
| <ul style="list-style-type: none">* A bipolar transistor requires a small amount of current flowing to keep the transistor on. While the current for one transistor may be negligible, it adds up when millions are switching simultaneously. The heat dissipated on bipolar limits the total number of transistors that can be built on the chip.* A BJT will consume more power in the on state. It can't switch with less than a 0.3V voltage drop.* BJTs function as regulators of currents as small current is regulating a large current.* BJTs are preferred for low current applications.* The bipolar transistor is liable for thermal runaway due to a negative temperature coefficient.* BJTs are used where we need high gain & fast response.* BJTs are relatively greater in size than FET of same rating. | <ul style="list-style-type: none">* Once the gate terminal of an FET has been charged, no more current is needed to keep that transistor on for the duration of time required.* FETs are preferred wide line or load variation & have low power consumption.* FET function as voltage regulators is co-efficient, stopping thermal runaway.* FETs are preferred in low-voltage application (less than 250V).* FET have a positive temperature coefficient, stopping thermal runaway.* FETs have low-medium gain.* FETs are smaller in size so area consumption of FET is less. So less made by FET's provides higher packing density as compared to BJTs. |

Forward biased junction diode

When a diode is connected in a forward bias condition, a negative voltage is applied to N-type material and a positive voltage is applied to the P-type material.

If this external voltage becomes greater than the value of the potential barrier, approx.

0.7 volts for silicon and 0.3 volts for Germanium, the potential barriers

Positive Edge Triggering :

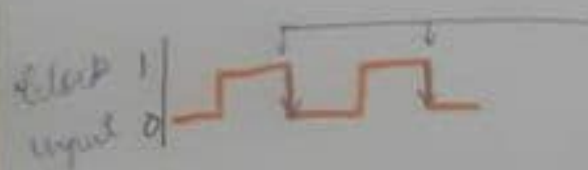
Here, the output responds to the changes in the input only at positive edge of the clock pulse at clock input.



Output responds only at the +ve edge of the pulse.

Negative Edge Triggering :

Here, the output responds to the changes in the input only at the negative edge of the clock input.



Output responds only at -ve edge of the pulse.

What is level triggering & edge triggering

Level Triggering: In level triggering, the output state is allowed to change according to input.

* It happens when **active level** is maintained at the **enable input**.

* There are 2 types of level triggered latches.

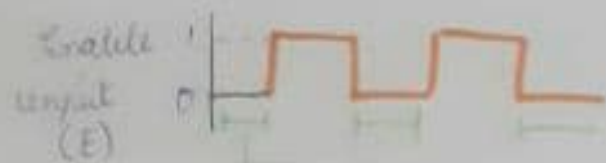
• **Positive level triggered**



Flip-flop is enabled only when the level of E input is high.

* The output of the flip-flop responds to the input changes only when its enable input is 1 (HIGH).

Negative level triggered.



Flip flops enabled only when the 0 level of E input is low

The output of the flip-flop responds to E the input changes only when its enable input is 0 (low)

Edge Triggering:

* In edge triggering, the output responds to the changes in the input only at +ve or -ve i.e. the clock pulse at clock input. There are of 2 types

Q) Draw and explain gated-latch logic diagram

(Q.R)

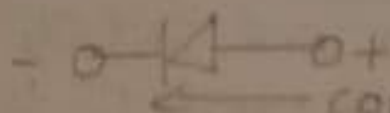
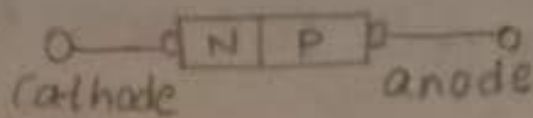
Draw the logic diagram of SR latch with control input using NAND gates

- * In SR latch output changes occur immediately after the input changes occur
- * i.e. the latch is **sensitive** to S & R inputs all the time
- * It can be easily **modified** to create a latch that is sensitive to these inputs only when **enable** input is active
- * Such a latch with enable input known as **gated SR latch**
- * The table shows the Truth table for gated latch
- * The circuit behaves like a SR latch when EN=1

Unit - 1 DIODES AND APPLICATIONS

Diode :- A diode is a two-terminal electronic component that conducts current primarily in one direction.

The positive side of the diode is called anode, and the negative one is called cathode.



PN Junction diode :-

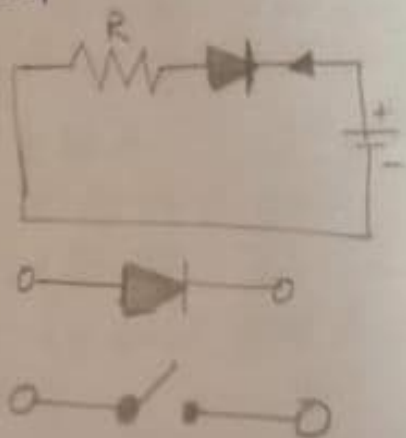
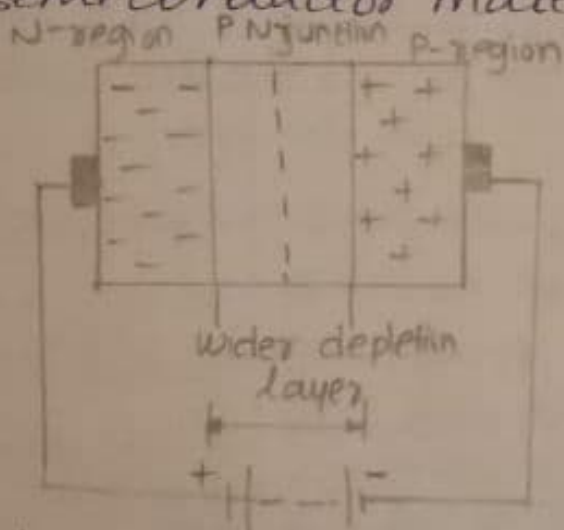
- In a piece of semiconductor, if one half is doped by p-type impurity and the other half is doped by n-type impurity, a PN junction is formed.
- The plane dividing the two halves or zones is called PN junction.
- The n-type material has high concentration of free electrons, while p-type material has high concentration of holes.
- There is a tendency of free electrons to diffuse over to the p side and the holes to the N side. This process is called diffusion.
- As the free electrons move across the junction from n type to p type, the donor atoms become positively charged. Hence a positive charge is built on the N-side of the junction.

- The free electrons that cross the junction uncover the negative uncovered negative acceptor ions by filling the holes. Therefore a negative charge on the p side prevents further diffusion of electrons into the p side.
- Similarly the net positive charge on the n side repels the hole crossing from p side to n side.
- Thus a barrier is set up near the junction which prevents the further movement of charge carriers i.e. electrons and holes.
- An electrostatic potential difference is established between p and n regions which are called the potential barrier, junction barrier, diffusion potential or contact potential V_0 varies with doping levels and temperature.
- V_0 is 0.3V for Ge and 0.72V for Si.

the holes in the p-type end are also attracted away from the junction towards the negative electrode.

The net result is that the depletion layer grows wider due to a lack of electrons and holes and presents a high impedance path, almost an insulator.

The result is that a high potential barrier is created thus preventing current from flowing through the semiconductor material



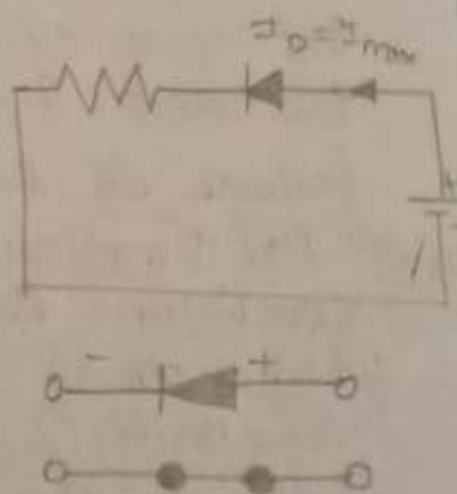
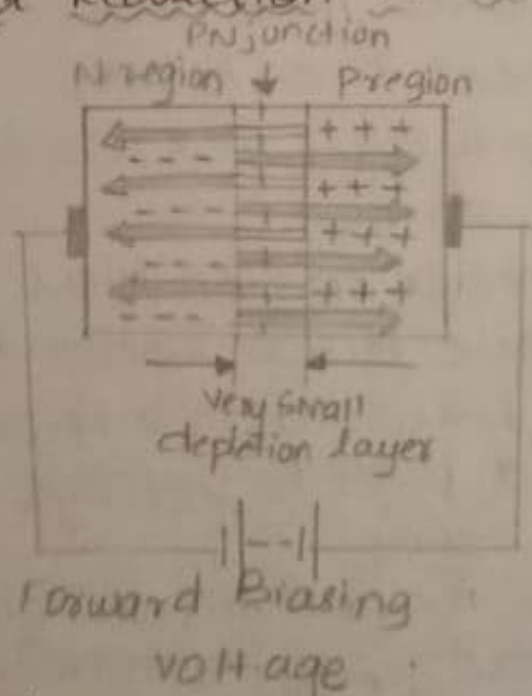
The condition represents a high resistance value to the PN junction and practically zero current flows through the junction diode with an increase in bias voltage. However, a very small leakage current does flow through the junction which can be measured in microamperes (μA).

If the reverse bias voltage V_R applied to the diode is increased to a sufficiently high enough value it will cause the

The application of a forward biasing voltage on the junction diode results in the depletion layer becoming very thin and narrow which represents a low impedance path through the junction thereby allowing high currents to flow.

The point at which this sudden increase in current takes place is represented on the static I-V characteristics curve above as the "knee" Point.

Forward biased Junction Diode showing a Reduction in the Depletion layer



This condition represents the low resistance path through the PN junction allowing very large currents to flow through the diode with only a small increase in bias voltage.

Implement a full adder using 2 half adders.

* A full adder can also be implemented with 2 half adders and one OR gate.

* The sum output from second half adder is the exclusive-OR output of the first half adder.

$$C_{out} = AB + A C_{in} + B C_{in}$$

$$AB + A C_{in} (B + \bar{B}) + B C_{in} (A + \bar{A})$$

$$AB + AB C_{in} + \bar{A} B C_{in} + AB C_{in} + \bar{A} B C_{in}$$

$$AB (1 + C_{in} + C_{in}) + \bar{A} B C_{in} + \bar{A} B C_{in}$$

$$AB + \bar{A} B C_{in} + \bar{A} B C_{in}$$

$$AB + C_{in} (\bar{A} B + \bar{A} B)$$

$$AB + C_{in} (A \oplus B)$$

2) Implement the given function using Multiplexer $F(x, y, z) = \Sigma(0, 2, 6, 7)$

Step 1: * Select the Multiplexer

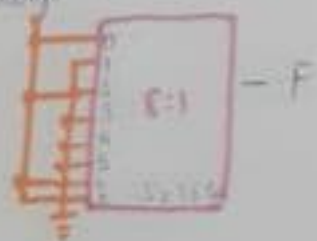
* Here, Boolean expression has 3 variables

* Thus we require $2^3 = 8:1$ multiplexer

Step 2: * Connect inputs which corresponds to the present minterms to logic 1

Step 3: * Connect remaining inputs to logic 0

Step 4: * Connect input variables to select lines of MUX



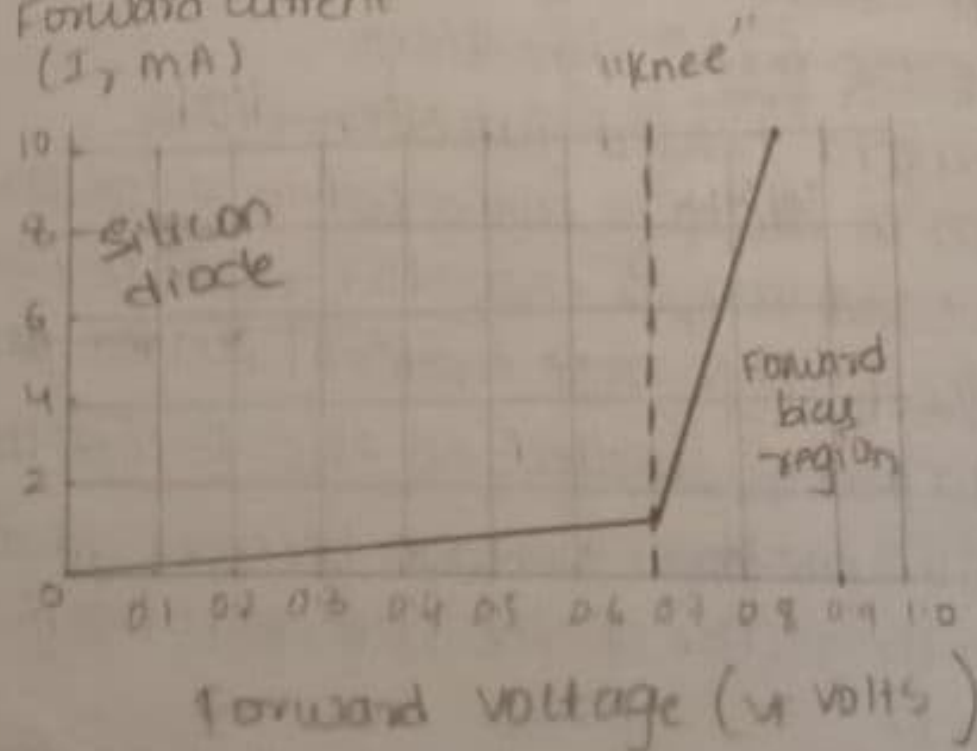
opposition will be overcome and current will start to flow.

This is because the negative voltage pushes or repels electrons towards the junction giving them the energy to cross over and combine with the holes being pushed in the opposite direction towards the junction by the positive voltage.

This results in a characteristic curve of zero current flowing up to this voltage point, called the "knee" on the static curves and then a high current flow through the diode with little increase in the external voltage.

Forward characteristics curve for a Junction diode

Forward current
(I_f , mA)

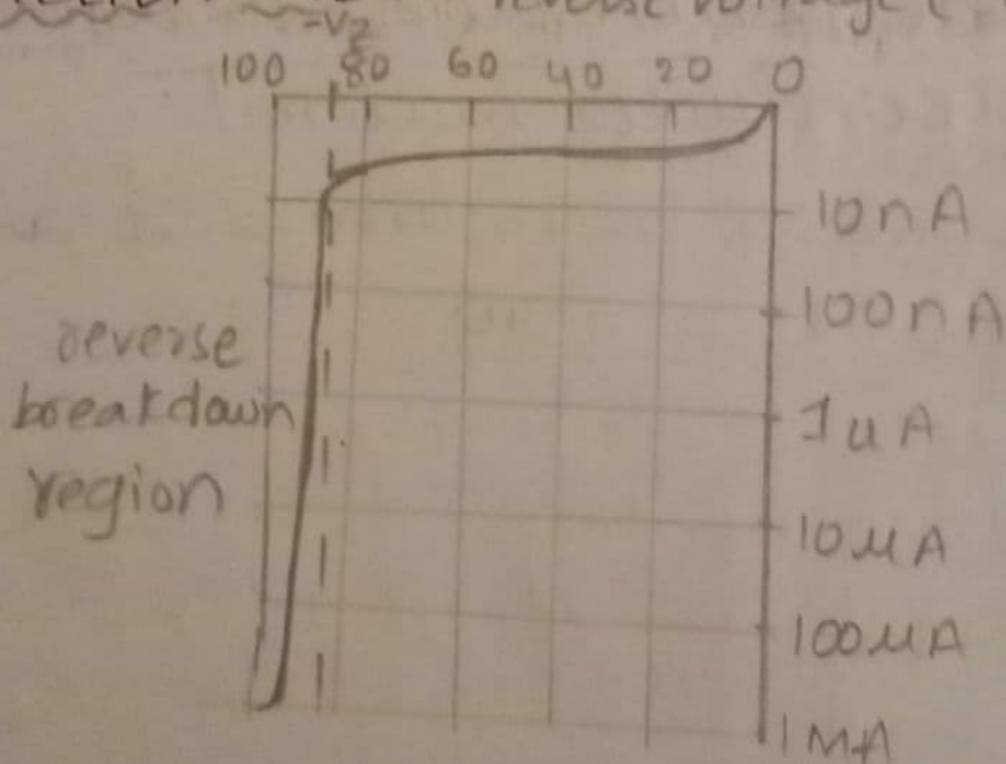


PN junction to overheat and fail due to the avalanche effect around the junction.

This may cause the diode to become shorted and will result in the flow of maximum circuit current, and this is shown as a steep downward slope in the reverse static characteristics curve.

Reverse characteristics curve for a

Junction diode reverse voltage ($-V_R$)



Reverse current (I_R)

dQ - change in charge stored in depletion region.

7) The diffusion capacitance at low frequencies is given by the formula

$$C_D = T^* \frac{g}{2} \quad (\text{low frequency})$$

8) The diffusion capacitance at high frequencies is inversely proportional to the frequency & is given by the formula:

$$C_D = g \left(\frac{1}{2\omega} \right)^{1/2}$$

Diffusion Capacitance

- 1) Diffusion Capacitor is the capacitance due to transport of charge carriers b/w two terminals of a device.
- 2) It is denoted by C_D
- 3) It occurs in FB diode electrons and holes near depletion region.
- 4) The change in charge w.r.t voltage results in capacitance called diffusion capacitance.
- 5) Diffusion capacitance is directly proportional to electric current or applied voltage.
- 6) In FB, the diffusion capacitance is the dominant and is given by

$$C_D = \frac{dQ}{dV} = \tau^* \frac{dI}{dV} = \tau^* g = \frac{\tau}{r}$$

C_D - diffusion capacitance

g - diode conductance

r - diode resistance

τ - time interval for change in

V - change in ^{voltage} applied voltage

The actual potential difference across the junction or diode is kept constant by the action of the depletion layer at approximately 0.3V for germanium, and approximately 0.7V for silicon junction diodes.

Since the diode can conduct "infinite" current above this knee point as it effectively becomes a short circuit, therefore resistors are used in series with the diode to limit its current flow.

Exceeding its maximum forward current specification causes the device to dissipate more power in the form of heat than it was designed for resulting in a very quick failure of the device.

31/05/20 PN Junction Under Reverse bias Condition:- Reverse biased Junction diode

When a diode is connected in a Reverse bias condition, a positive voltage is applied to the N-type

Material and a negative voltage is applied to the P-type material.

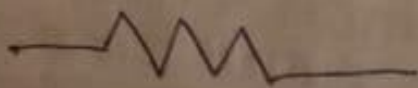
The positive voltage applied to the N-type material attracts electrons towards the positive electrode and away from the junction, while

UNIT - 1 Continuation.

Diode resistance.

1. A PN Junction diode is a unidirectional two-terminal semiconductor device.
2. It conducts only in one direction and offers high resistance in other direction.
3. In ideal diode offers zero resistance when FB and infinite resistance when it is reversed bias.
4. In practical diode it does not offer zero resistance when FB and infinite resistance in reverse bias.
5. Diode resistance is the resistance which a diode offers in a circuit.
6. Diodes are not linear devices.
7. The resistance of diodes does not vary directly and proportionally to the amount of voltage & current applied to them.

Symbol



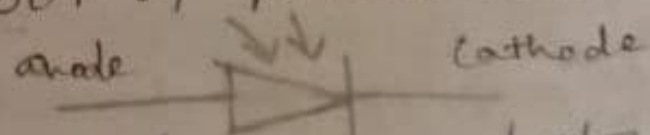
8. Resistance can be calculated by the formula $R = \frac{V}{I}$

Applications

- used in solar cell panels.
- used in logic circuits
- used in the detection circuits
- used in character recognition circuits
- used in exact measurement of the intensity of light in science & industry
- Photodiodes are faster and more complex than normal PN junction diode and hence are frequently used for lighting regulation and optical communication

Photodiode
A photodiode is a p-n junction diode that consumes light energy to produce an electric current. They are also called a photo detector, a light detector, and a photo-sensor. Photodiodes are designed to work in reverse bias condition. Typical photodiode materials are silicon, Germanium and Indium Gallium Arsenide.

Symbol of photodiode



The symbol of the photodiode is similar to that of an LED, but here the arrow points inwards.
Working

A photodiode is subjected to photons in the form of light which affects the generation of electron hole pairs. If the energy of the falling photons is greater than the energy gap of the s.c material, electron hole pairs are created near the depletion region of the diode. The electron hole pairs created are separated from each other before

Transition Capacitance.

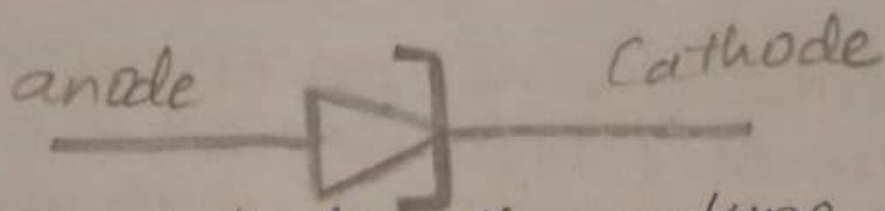
- 1) The amount of capacitance changed with increase in voltage is called Transition capacitance
- 2) The transition capacitance is also known as depletion region capacitance, junction capacitance
- 3) It is denoted as C_T

Tunnel diode is a two terminal p-n junction. A Tunnel diode is a heavily doped p-n junction diode in which electric current decreases as the voltage increases.

In tunnel diode, electric current is caused by "Tunneling".

The tunnel diode is used as a very fast switching device in computers. It is also used in high frequency oscillators and amplifiers.

Symbol



In tunnel diode, the p-type s.c. act as anode and n-type s.c. act as Cathode.

We know that a anode is a +vely charged electrode which emits electrons. N type s.c. emits or produces electrons so it is referred to as Cathode.

P-type s.c. attracts electron emitted from the n-type s.c. so P-type s.c. is referred to as the anode.

- 4) The capacitance which appears b/w positive ion layer in n-region and negative ion layer in p-region
- 5) The transition capacitance is very small as compared to the diffusion capacitance
- 6) In reverse bias, the capacitance is the dominant and is given by:

$$C_T = \epsilon \cdot \frac{A}{w}$$

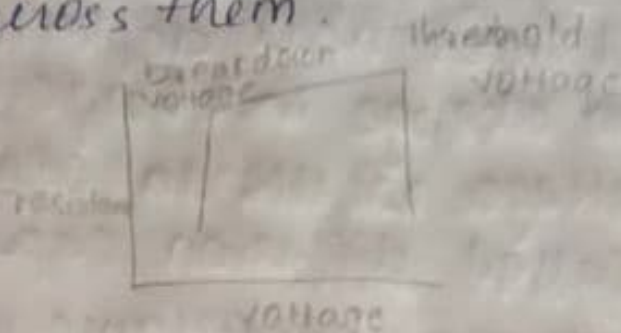
Where C_T = transition capacitance
 A - diode cross sectional area
 w - depletion region width.

9 Diodes are non linear

10 Diodes are s.c devices doped with impurities, they do not function like linear devices.

11 The resistance changes based on voltage and current that fall across them.

Graph.



12 The diode has two key resistance they are breakdown voltage and threshold voltage

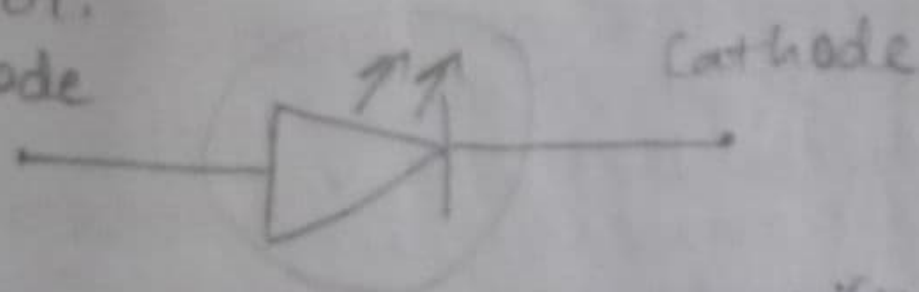
13 Diode resistance $R = \frac{V_T}{I_d}$

14 diode resistance is equal to thermal voltage, V_T divided by the current I_d passing through diode

15 The thermal voltage of the diode is approximately 25mV at 300K which is room temperature

where k is Boltzmann constant

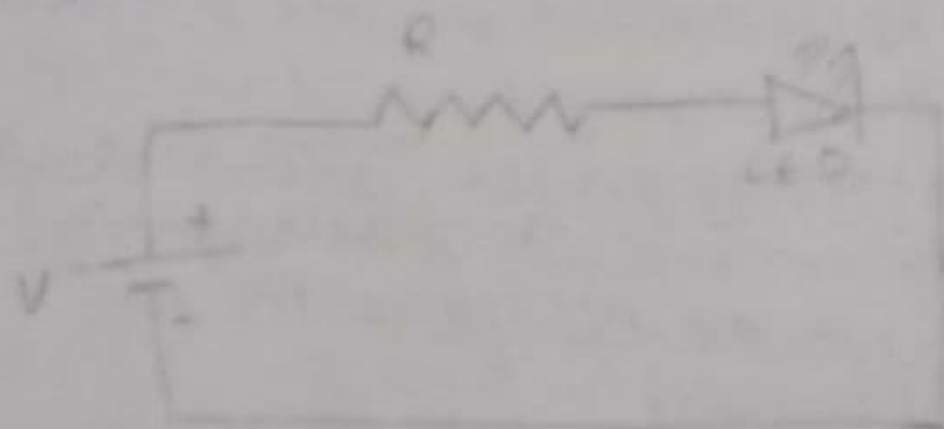
Symbol.
anode



The LED's also have a specific drop in voltage forward in cases where it is used typical circuits like a conventional diode.

The drop in voltage depends on the current of the LED, the colour of produced light, etc.

There are different values in the drop of voltage that would vary from 1.5V to 2.5V current for 10 to 50 mA current.



Working LED circuit

The holes in the VB and free electrons in CB. when there is a FB in the Pn junction, the electron which is

Recombining due to the electric field of the junction. The direction of the electric field in the ~~force~~ the electron to move towards the n side and consequently the holes move towards the p side. As a result of the increase in the number of electrons on the n side and holes on the p side a rise in the electromotive force are observed.

The magnitude of the electromotive force created depends directly upon the intensity of incident light.

This effect of the proportional change in photocurrent with the change in light intensity can be easily observed by applying a reverse bias.

Built in lenses and optical filters may be used to enhance the power and productivity of a photodiode.

a part of the n type s.c material would
over run the pn junction & join with
the holes in the p type s.c material
therefore the free electron would be
at higher energy bands.

In LED, energy discharged in light
form hinges on the forbidden energy
gap. The color and wavelength of
the light emitted can be determined
by doping it with several impurities

Uses

used in optical communication
alarms, robotics.

used for TV back lighting

uses in displays

used in automotive

used in the dimming of lights.

LED

LED converts ~~light energy~~ into electrical energy when current passes through the LED, ^{into light energy} the electrons recombine with holes emitting light in the process.

It is a specific type of diode having similar characteristics as the p-n junction diode. LED is heavily doped PN junction diode.

This means that an LED allows the flow of current in its forward direction while it blocks the flow in the reverse direction.

Light emitting diodes are built using a weak layer of heavily doped s.c. material.

An LED will emit a colored light at a particular spectral wavelength when F-B

Advantages

long life, low noise, Low power consumption, High speed operation

Disadvantages

Tunnel diode cannot be fabricated in large number

Being a two terminal device, the input and output are not isolated from one another

Applications of tunnel diode

Tunnel diodes are used as logic

→ memory storage devices.

→ used in relaxation oscillator circuit

→ used as an ultra high speed switch

→ used in fm receivers

Diode switching times
while changing the bias conditions
the diode undergoes a transient
response.

The response of a system to any
sudden change from an equilibrium
position is called transient response.

The sudden change from forward
to reverse and from reverse
to forward bias, affect the circuit.
The time taken before the diode
recovers its steady state is called
as Recovery time.

The time interval taken by diode
to switch from RB to FB state
is called as Forward recovery time.

The time interval taken by the
diode to switch from FB state
to RB state is called
Reverse recovery time.

- For all the positive half cycles of input AC signal the diode D_1 is the forward bias and it conducts current. Now the diode D_2 is in reverse bias and it does not conduct current.
- For all the negative half cycles of input AC signal the diode D_2 is in forward bias and it conducts current. Now the diode D_1 is in reverse bias and does not conduct current.
- Both positive and negative half cycles of input AC signal are converted into rectified DC output.
- The ratio of output DC power to input AC power is called efficiency of full wave rectifier.

$$\eta = \frac{0.812 R_L}{r_f + R_L}$$

- The maximum efficiency of full wave rectifier is 81.2%.

The ratio of output DC power to input AC power is called efficiency of half wave rectifier

$$\eta = \frac{\text{output DC power}}{\text{input AC power}} = \frac{0.406 R_L}{r_f + R_L}$$

where R_L = Load resistance

r_f = forward resistance of diode

Maximum efficiency of half wave rectifier is 40.6%

and maintains the voltage across the load current.

6) Applying KCL at the node
we get $I = I_L + I_Z$

7) voltage across the load resistance
is given as $V_L \rightarrow$ load voltage
 $V_Z \rightarrow$ Zener voltage
$$V_L = V_Z + I_Z R_Z$$

8) zener diode are available in
the range of $2V$ to $200V$

9) the breakdown voltage is different
from the one zener diode to another
zener diode. because of different
doping concentration.

Limitations

The circuit is used only when the
changes in the load current
and line voltage are small.

Classification of Rectifiers

Using one or more diodes in the circuit, following rectifiers circuits can be designed.

- 1) Half wave rectifier
- 2) Full wave rectifier
- 3) Bridge Rectifier

Half wave rectifier

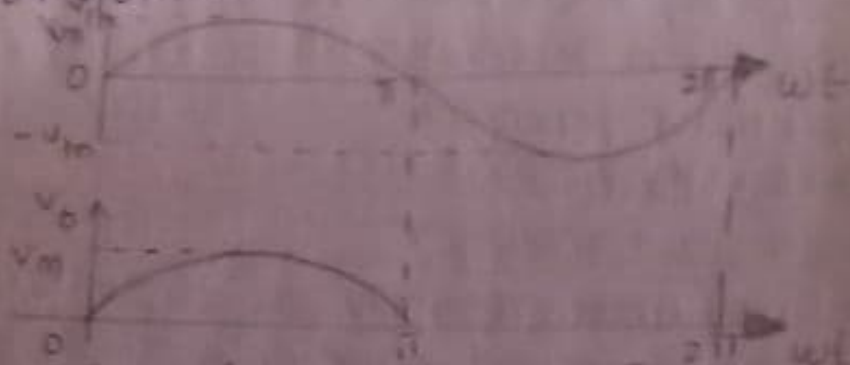
A Half wave rectifier as shown in fig. The device which converts ac voltage into a pulsating voltage using only one half cycle of the applied ac voltage.



Basic structure of half wave rectifier

- A half wave rectifier can be constructed with a single p-n junction diode.
- The input AC signal to be rectified is applied across the primary of the transformer and output DC signal is taken across the load resistance (R_L) connected across secondary.
- The AC voltage is applied to the rectifier circuit using step down T/F rectifying element i.e. p-n junction diode and the source of AC voltage all connected in series.

- The ac voltage is applied to the rectifier circuit using step down transformer



input and output wave forms of a half wave rectifier

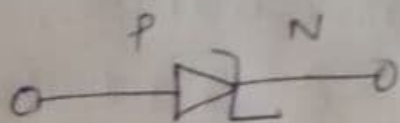
$$V = V_m \sin(\omega t)$$

- The input to the rectifier circuit, where V_m is the peak value of secondary ac voltage
- Operation:
 - For all the positive half cycles of input AC signal, the diode D is in forward bias and hence it conducts current. So current passes through load resistance (R_L)
 - For all the negative half cycles of input ac signal, the diode D is in reverse bias and it does not conduct current. So no current flows through load resistance (R_L)
 - Only positive half cycle of input AC signal is converted into rectified DC output.

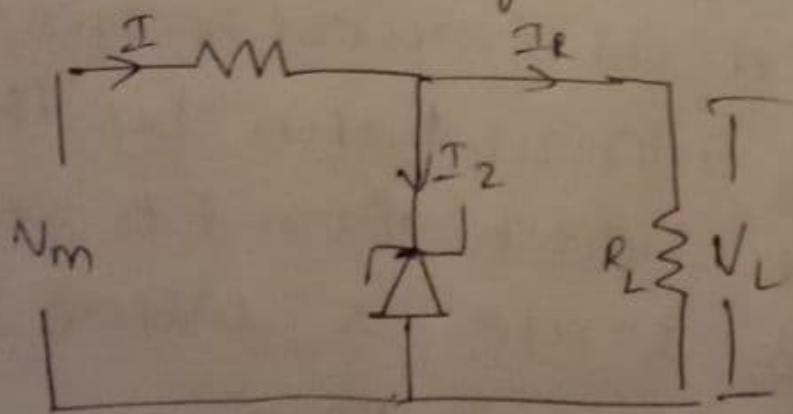
Zener Diode.

- 1) A properly doped p-n junction diode which has sharp breakdown voltage is called a zener diode.
- 2) Zener diode can be used as voltage regulator by connecting it in R-B.

3) Symbol

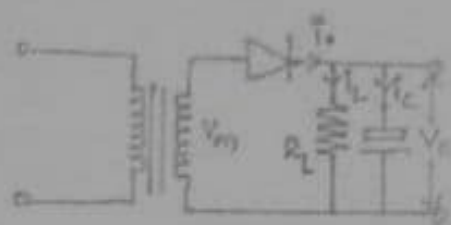


- 4) A zener diode can be used as a voltage regulator to provide constant voltage from a source whose voltage may vary over sufficient range.



- 5) The i/p voltage V to the zener regulator is greater than breakdown voltage V' the diode function in the zener region.

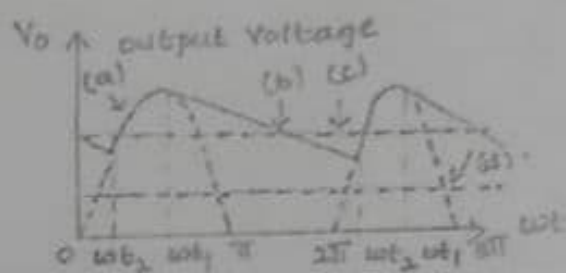
CAPACITOR FILTER WITH HWR



Cut In angle = ωt_2

Cut out angle = ωt_1

$$\omega t_1 = \pi - \tan^{-1} \omega C R_L$$



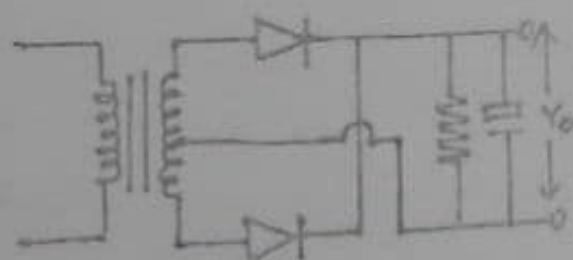
(a) Capacitor charging through diode
(ωt_2 to ωt_1)

(b) Capacitor discharging through R_L
(ωt_1 to ωt_2)

(c) Average (DC) voltage with filter

(d) Average (DC) voltage without filter.

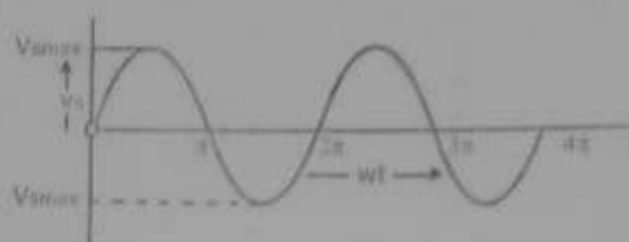
CAPACITOR FILTER WITH FWR



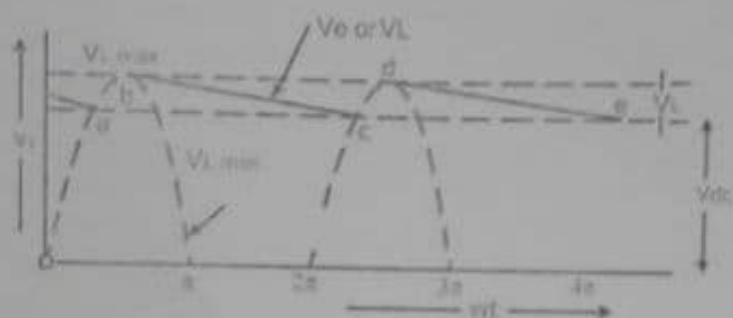
offers high Impedance to the dc component.

b) The ripples get passed through capacitor C and only dc component flow through the load resistance R_L

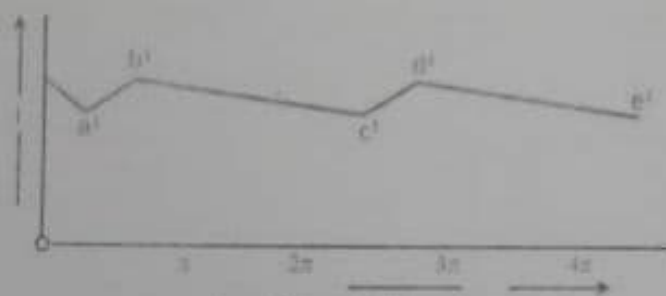
Diagrams in pdf



Input voltage Waveform to Rectifier



Rectified and filtered Output Voltage Waveform



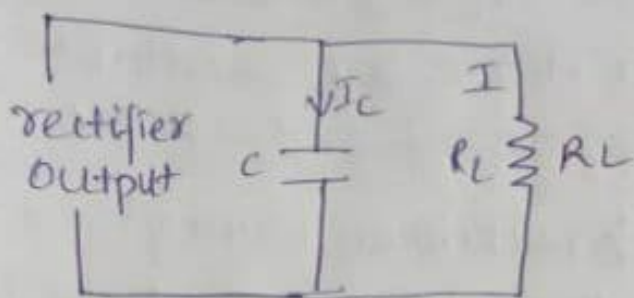
Load Current Waveform

Half-wave Rectifier With Shunt Capacitor Filter

CircuitToday.com

Rectifier with Capacitor filter.

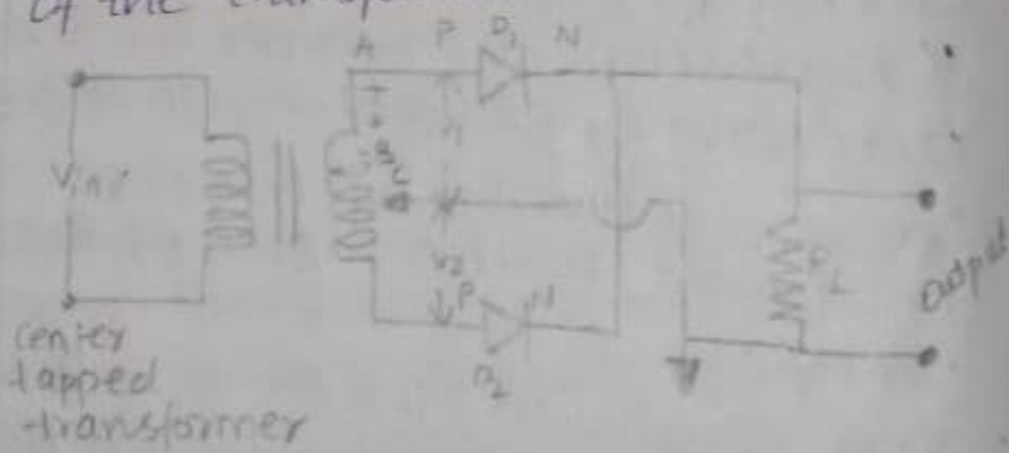
- 1) The designing of this circuit can't be done with a capacitor as well as load resistor.
- 2) The rectifier voltage is given across the terminal of a capacitor.



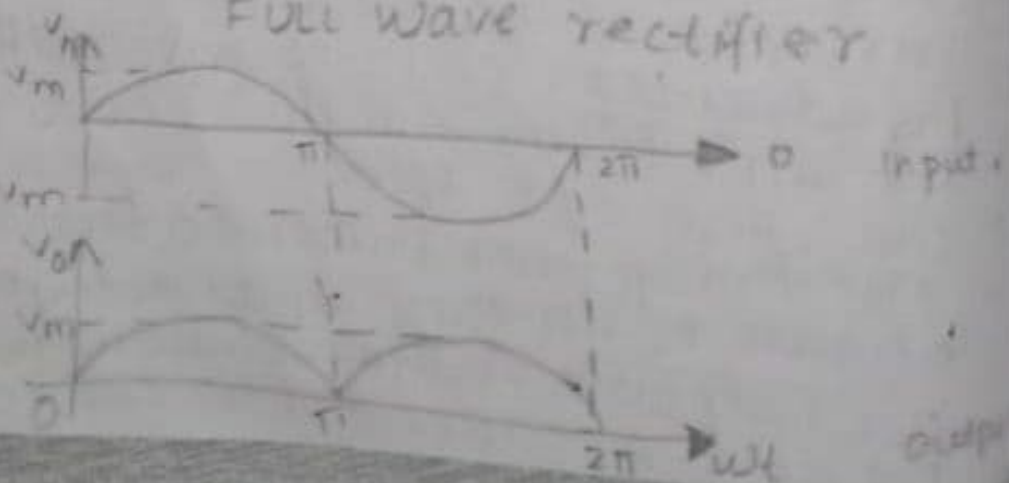
- 3) The function of a capacitor filter may be viewed in terms of impedance.
- 4) The large value of capacitor C offers low impedance.
- 5) Capacitor filter is very popular because of its low cost, small size, light weight and good characteristics.
- 5) The capacitor C offers low impedance shunt path to the ac components or ripples but

7/9/20 Full Wave Rectifier:-

- A full wave rectifier converts an ac voltage into a pulsating dc voltage using both half cycles of the applied ac voltage.
- In order to rectify both the half cycles of ac input, two diodes are used in this circuit.
- The diodes feed a common load R_L with the help of a center-tap transformer.
- A center tap transformer is the one which produces two sinusoidal waveforms of same magnitude and frequency but out of phase with respect to the ground in the secondary winding of the transformer.



FULL Wave rectifier



Analog and Digital Electronics

Unit - I

- 1) PN Junction diode.
- 2) Diode resistance
- 3) diffusion capacitance
- 4) diode switching times.
- 5) Tunnel diode
- 6) photodiode
- 7) LED
- 8) zener diode.
- 9) Half wave rectifier
- 10) Full wave rectifier
- 11) Capacitor filter.